

# MPSA63, MPSA64

MPSA64 is a Preferred Device

## Darlington Transistors

### PNP Silicon

#### Features

- These are Pb-Free Devices\*

#### MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector-Emitter Voltage	$V_{CES}$	-30	Vdc
Collector-Base Voltage	$V_{CBO}$	-30	Vdc
Emitter-Base Voltage	$V_{EBO}$	-10	Vdc
Collector Current - Continuous	$I_C$	-500	mAdc
Total Device Dissipation @ $T_A = 25^\circ\text{C}$ Derate above $25^\circ\text{C}$	$P_D$	625 5.0	mW mW/ $^\circ\text{C}$
Total Device Dissipation @ $T_C = 25^\circ\text{C}$ Derate above $25^\circ\text{C}$	$P_D$	1.5 12	W mW/ $^\circ\text{C}$
Operating and Storage Junction Temperature Range	$T_J, T_{stg}$	-55 to +150	$^\circ\text{C}$

#### THERMAL CHARACTERISTICS

Rating	Symbol	Max	Unit
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	200	$^\circ\text{C}/\text{W}$
Thermal Resistance, Junction-to-Case	$R_{\theta JC}$	83.3	$^\circ\text{C}/\text{W}$

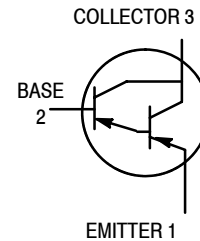
Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

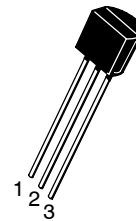


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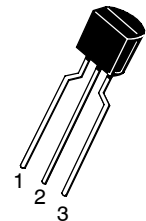
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TO-92  
CASE 29  
STYLE 1

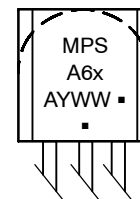


STRAIGHT LEAD  
BULK PACK



BENT LEAD  
TAPE & REEL  
AMMO PACK

#### MARKING DIAGRAM



- xx = 3, or 4
- A = Assembly Location
- Y = Year
- WW = Work Week
- = Pb-Free Package

(Note: Microdot may be in either location)

#### ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 2 of this data sheet.

**Preferred** devices are recommended choices for future use and best overall value.

# MPSA63, MPSA64

## ELECTRICAL CHARACTERISTICS ( $T_A = 25^\circ\text{C}$ unless otherwise noted)

Characteristic	Symbol	Min	Max	Unit
<b>OFF CHARACTERISTICS</b>				
Collector-Emitter Breakdown Voltage ( $I_C = -100 \mu\text{Adc}$ , $V_{BE} = 0$ )	$V_{(BR)CES}$	-30	-	Vdc
Collector Cutoff Current ( $V_{CB} = -30 \text{ Vdc}$ , $I_E = 0$ )	$I_{CBO}$	-	-100	nAdc
Emitter Cutoff Current ( $V_{EB} = -10 \text{ Vdc}$ , $I_C = 0$ )	$I_{EBO}$	-	-100	nAdc
<b>ON CHARACTERISTICS (Note 1)</b>				
DC Current Gain ( $I_C = -10 \text{ mAdc}$ , $V_{CE} = -5.0 \text{ Vdc}$ )	MPSA63 MPSA64	$h_{FE}$	5,000 10,000	- -
( $I_C = -100 \text{ mAdc}$ , $V_{CE} = -5.0 \text{ Vdc}$ )	MPSA63 MPSA64		10,000 20,000	- -
Collector-Emitter Saturation Voltage ( $I_C = -100 \text{ mAdc}$ , $I_B = -0.1 \text{ mAdc}$ )	$V_{CE(sat)}$	-	-1.5	Vdc
Base-Emitter On Voltage ( $I_C = -100 \text{ mAdc}$ , $V_{CE} = -5.0 \text{ Vdc}$ )	$V_{BE(on)}$	-	-2.0	Vdc
<b>SMALL-SIGNAL CHARACTERISTICS</b>				
Current-Gain — Bandwidth Product (Note 2) ( $I_C = -100 \text{ mAdc}$ , $V_{CE} = -5.0 \text{ Vdc}$ , $f = 100 \text{ MHz}$ )	$f_T$	125	-	MHz

1. Pulse Test: Pulse Width  $\leq 300 \mu\text{s}$ ; Duty Cycle  $\leq 2.0\%$ .
2.  $f_T = |h_{fe}| \cdot f_{test}$ .

## ORDERING INFORMATION

Device	Package	Shipping <sup>†</sup>
MPSA63G	TO-92 (Pb-Free)	5000 Units / Bulk
MPSA63RLRAG	TO-92 (Pb-Free)	2000 / Tape & Reel
MPSA64G	TO-92 (Pb-Free)	5000 Units / Bulk
MPSA64RLRAG	TO-92 (Pb-Free)	2000 / Tape & Reel
MPSA64RLRMG	TO-92 (Pb-Free)	2000 / Ammo Pack

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

# MPSA63, MPSA64

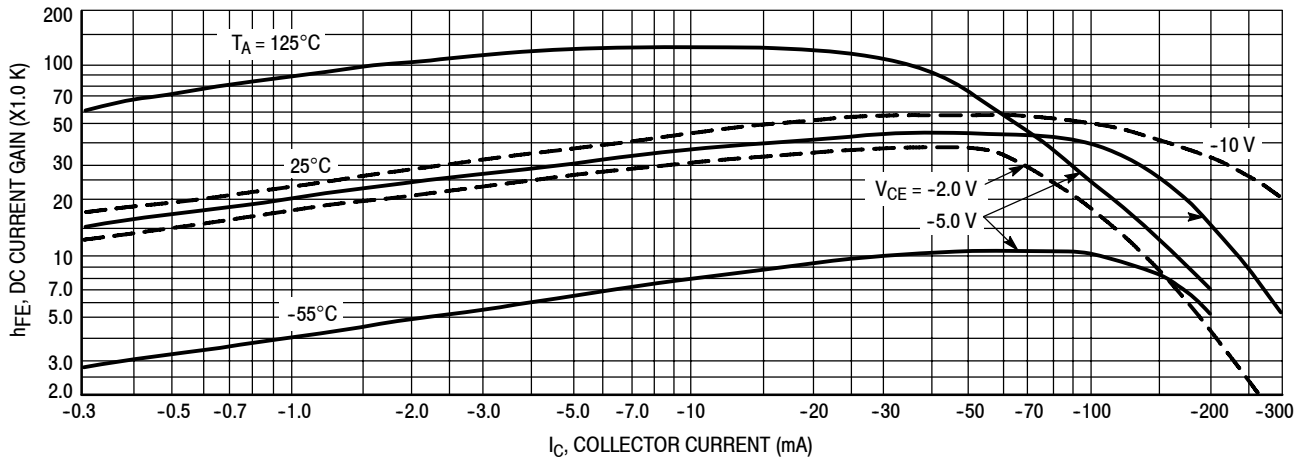


Figure 1. DC Current Gain

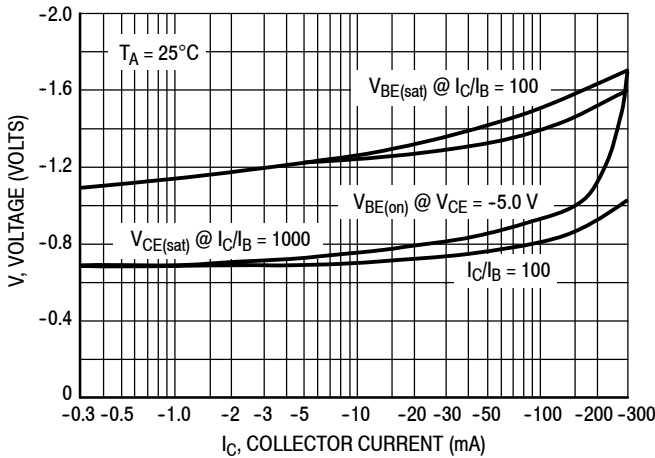


Figure 2. "On" Voltage

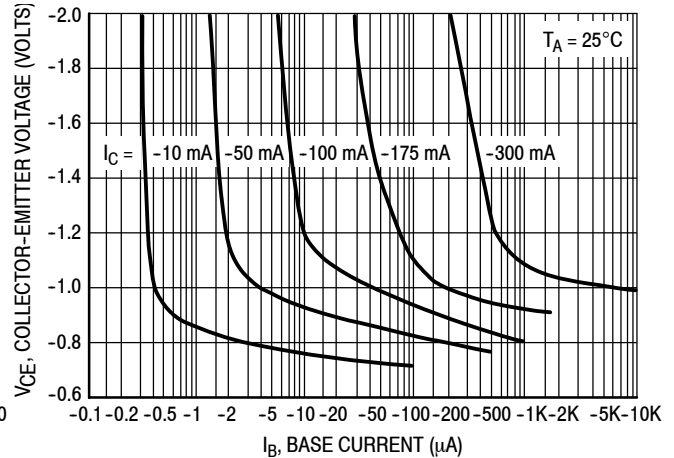


Figure 3. Collector Saturation Region

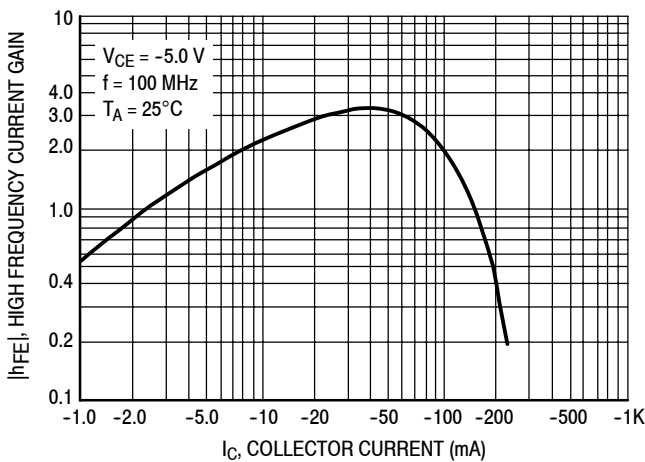


Figure 4. High Frequency Current Gain

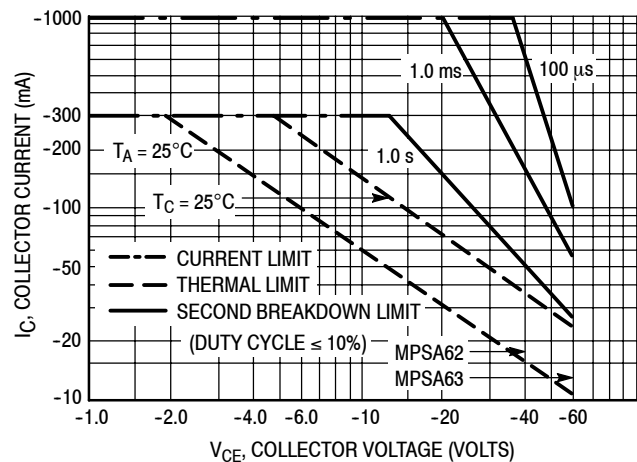
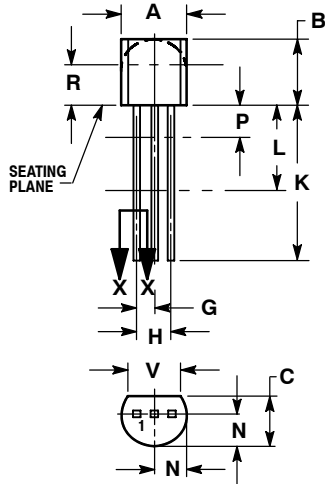


Figure 5. Active Region, Safe Operating Area

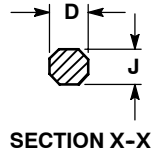
# MPSA63, MPSA64

## PACKAGE DIMENSIONS

TO-92 (TO-226)  
CASE 29-11  
ISSUE AM



STRAIGHT LEAD  
BULK PACK

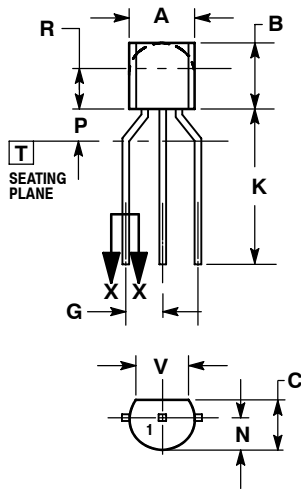


SECTION X-X

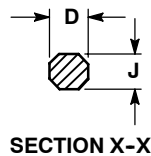
NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. CONTOUR OF PACKAGE BEYOND DIMENSION R IS UNCONTROLLED.
4. LEAD DIMENSION IS UNCONTROLLED IN P AND BEYOND DIMENSION K MINIMUM.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.175	0.205	4.45	5.20
B	0.170	0.210	4.32	5.33
C	0.125	0.165	3.18	4.19
D	0.016	0.021	0.407	0.533
G	0.045	0.055	1.15	1.39
H	0.095	0.105	2.42	2.66
J	0.015	0.020	0.39	0.50
K	0.500	---	12.70	---
L	0.250	---	6.35	---
N	0.080	0.105	2.04	2.66
P	---	0.100	---	2.54
R	0.115	---	2.93	---
V	0.135	---	3.43	---



BENT LEAD  
TAPE & REEL  
AMMO PACK



SECTION X-X


NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS.
3. CONTOUR OF PACKAGE BEYOND DIMENSION R IS UNCONTROLLED.
4. LEAD DIMENSION IS UNCONTROLLED IN P AND BEYOND DIMENSION K MINIMUM.

DIM	MILLIMETERS	
	MIN	MAX
A	4.45	5.20
B	4.32	5.33
C	3.18	4.19
D	0.40	0.54
G	2.40	2.80
J	0.39	0.50
K	12.70	---
N	2.04	2.66
P	1.50	4.00
R	2.93	---
V	3.43	---

STYLE 1:

1. EMITTER
2. BASE
3. COLLECTOR

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